UNIKC Semiconductor

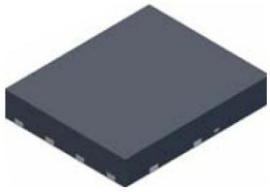
RoHS Compliant

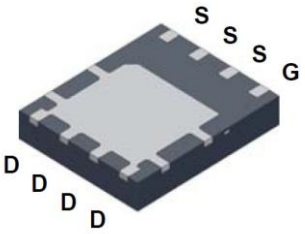
P0303BKA

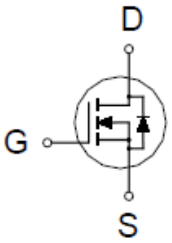
N-Channel Enhancement Mode MOSFET

PRODUCT SUMMARY

$V_{(BR)DSS}$	$R_{DS(ON)}$	I_D
30V	3.5mΩ @V_{GS} = 10V	89A







PDFN 5*6P

ABSOLUTE MAXIMUM RATINGS (T_A = 25 °C Unless Otherwise Noted)

PARAMETERS/TEST CONDITIONS		SYMBOL	LIMITS	UNITS
Drain-Source Voltage		V_{DS}	30	V
Gate-Source Voltage		V_{GS}	±20	
Continuous Drain Current[3]	T_C = 25 °C	I_D	89	A
	T_C = 100 °C		56	
Pulsed Drain Current[1]		I_{DM}	180	
Continuous Drain Current	T_A = 25 °C	I_D	19	
	T_A = 70 °C		12	
Avalanche Current		I_{AS}	59	
Avalanche Energy	L = 0.1mH	E_{AS}	174	mJ
Power Dissipation	T_C = 25 °C	P_D	48	W
	T_C = 100 °C		19	
	T_A = 25 °C		2.1	
	T_A = 70 °C		1.4	
Operating Junction & Storage Temperature Range		T_J, T_{STG}	-55 to 150	°C

UNIKC Semiconductor

RoHS Compliant

P0303BKA

N-Channel Enhancement Mode MOSFET

THERMAL RESISTANCE RATINGS

THERMAL RESISTANCE		SYMBOL	TYPICAL	MAXIMUM	UNITS
Junction-to-Case	Steady-State	$R_{\theta JC}$		2.6	°C / W
Junction-to-Ambient[2]	Steady-State	$R_{\theta JA}$		57	

[1]Pulse width limited by maximum junction temperature.

[2]The value of $R_{\theta JA}$ is measured with the device mounted on 1in^2 FR-4 board with 2oz. Copper, in a still air environment with T_A = 25°C. The value in any given application depends on the user's specific board design.

[3]Package limitation current is 78A.

ELECTRICAL CHARACTERISTICS (T_J = 25 °C, Unless Otherwise Noted)

PARAMETER	SYMBOL	TEST CONDITIONS	LIMITS			UNIT
			MIN	TYP	MAX	
STATIC						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	V_{GS} = 0V, I_D = 250μA	30			V
Gate Threshold Voltage	$V_{GS(th)}$	V_{DS} = V_{GS}, I_D = 250μA	1.0	1.5	3.0	
Gate-Body Leakage	I_{GSS}	V_{DS} = 0V, V_{GS} = ±20V			±100	nA
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS} = 24V, V_{GS} = 0V			1	μA
		V_{DS} = 20V, V_{GS} = 0V , T_J = 55 °C			10	
Drain-Source On-State Resistance[1]	$R_{DS(ON)}$	V_{GS} = 4.5V, I_D = 16A		4.6	6.5	mΩ
		V_{GS} = 10V, I_D = 20A		2.9	3.5	
Forward Transconductance[1]	g_{fs}	V_{DS} = 5V, I_D = 20A		65		S
DYNAMIC						
Input Capacitance	C_{iss}	V_{GS} = 0V, V_{DS} = 15V, f = 1MHz		2840		pF
Output Capacitance	C_{oss}			443		
Reverse Transfer Capacitance	C_{rss}			280		
Gate Resistance	R_g	V_{GS} = 0V, V_{DS} = 0V, f = 1MHz		0.7		Ω
Total Gate Charge[2]	$Q_{g(V_{GS}=10V)}$	V_{DS} = 0.5$V_{(BR)DSS}$, V_{GS} = 10V, I_D = 20A		53		nC
	$Q_{g(V_{GS}=4.5V)}$			26		
Gate-Source Charge[2]	Q_{gs}			9.4		
Gate-Drain Charge[2]	Q_{gd}			12.6		
Turn-On Delay Time[2]	$t_{d(on)}$	V_{DS} = 15V, I_D ≅ 1A, V_{GS} = 10V, R_{GEN} = 6Ω		20.4		nS
Rise Time[2]	t_r			8.1		
Turn-Off Delay Time[2]	$t_{d(off)}$			113		
Fall Time[2]	t_f			15.7		

UNIKC Semiconductor

RoHS Compliant

P0303BKA

N-Channel Enhancement Mode MOSFET

SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS (T_J = 25 °C)						
Continuous Current[3]	I_S				89	A
Forward Voltage[1]	V_{SD}	I_F = 20A, V_{GS} = 0V			1	V
Reverse Recovery Time	t_{rr}	I_F = 20A, dI_F/dt = 100A / µS		32		nS
Reverse Recovery Charge	Q_{rr}			18		nC

[1]Pulse test : Pulse Width ≤ 300 µsec, Duty Cycle ≤ 2%.

[2]Independent of operating temperature.

[3]Package limitation current is 78A.

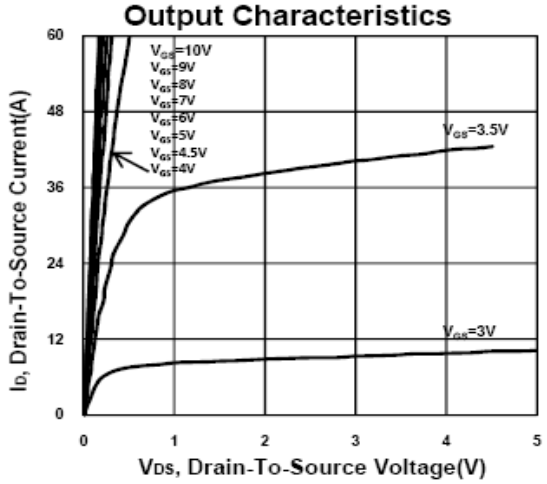
UNIKC Semiconductor

RoHS Compliant

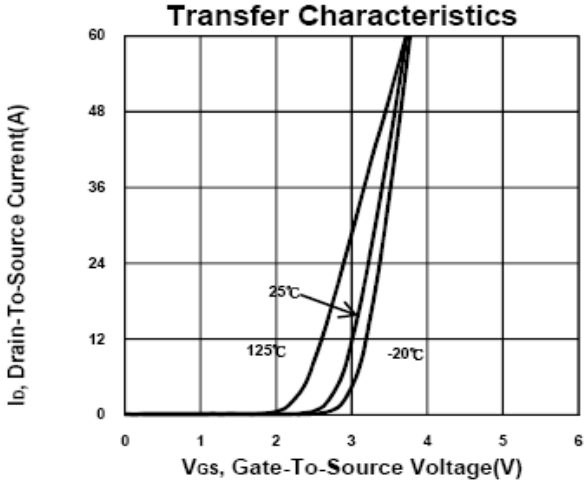
P0303BKA

N-Channel Enhancement Mode MOSFET

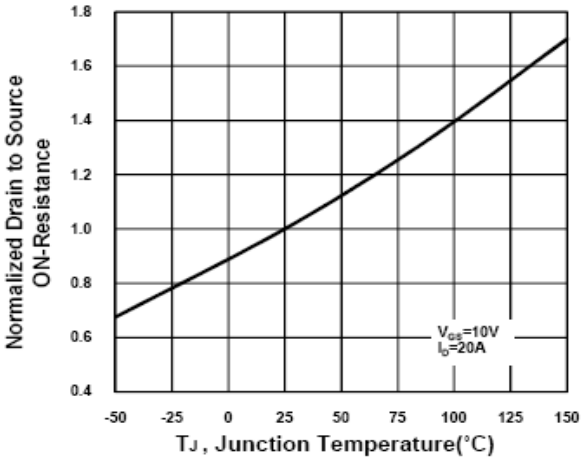
Output Characteristics



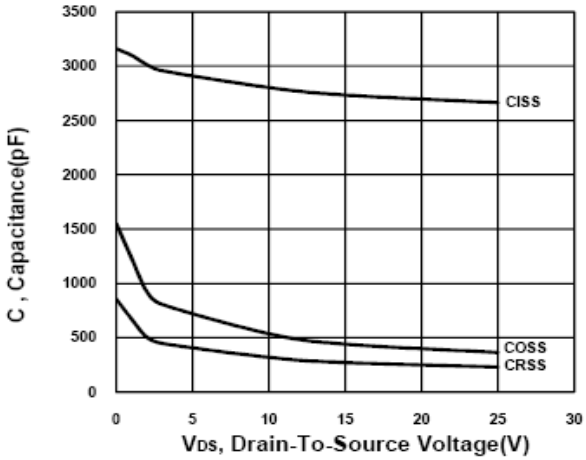
Transfer Characteristics



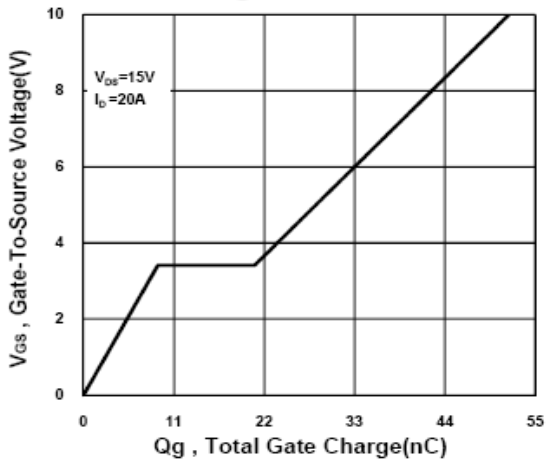
On-Resistance VS Temperature



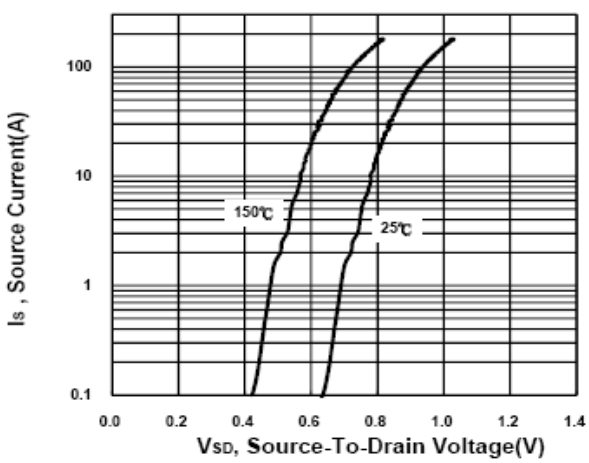
Capacitance Characteristic



Gate charge Characteristics



Source-Drain Diode Forward Voltage



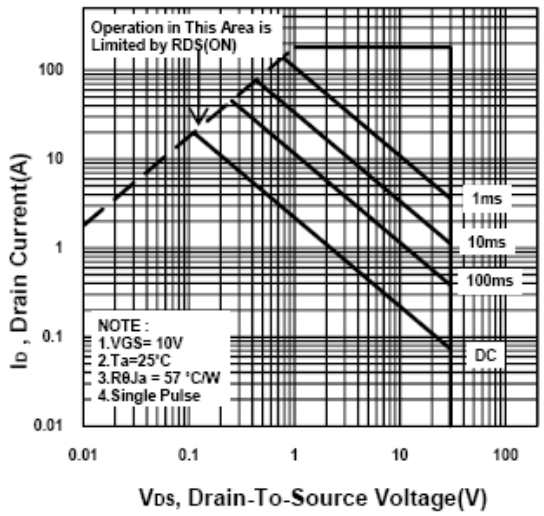
UNIKC Semiconductor

RoHS Compliant

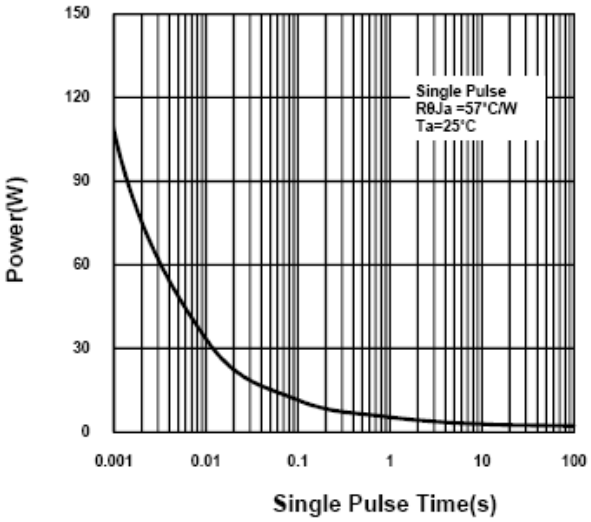
P0303BKA

N-Channel Enhancement Mode MOSFET

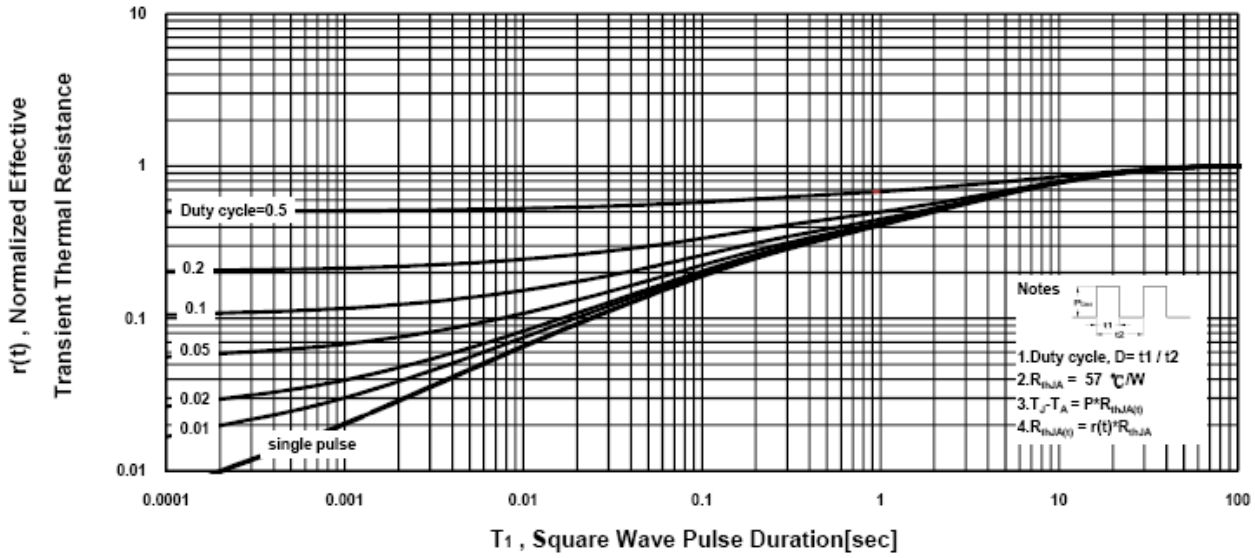
Safe Operating Area



Single Pulse Maximum Power Dissipation



Transient Thermal Response Curve



P0303BKA

N-Channel Enhancement Mode MOSFET

Package Dimension

PDFN 5x6P MECHANICAL DATA

Dimension	mm			Dimension	mm		
	Min.	Typ.	Max.		Min.	Typ.	Max.
A	4.8		5.15	J	3.33		3.78
B	5.44		5.9	K	0.9		
C	5.9		6.35	L	0.35		0.712
D	0.33		0.51	M	0°		12°
E		1.27		N	4.8		5.5
F	0.8		1.25	O	0.05		0.3
G	0.15		0.34	P	0.06		0.2
H	3.61		4.31	S	3.69		4.19
I	0.35		0.71